

## FACILITATING THE SPREAD OF ENCAPSULANT BETWEEN SURFACES OF ELECTRONIC DEVICES

Abstract of the Disclosure

An electronic device having an extensive narrow passageway may be effectively encapsulated by forming openings in one or more of the surfaces defining the encapsulation region. Encapsulation material may then be injected through these openings to fill a narrow, difficult to access region between two surfaces being encapsulated.

In some cases, the encapsulant may be applied progressively, starting with a central port and applying the encapsulant in a radially expanding front through radially displaced ports.